

### ■ Features

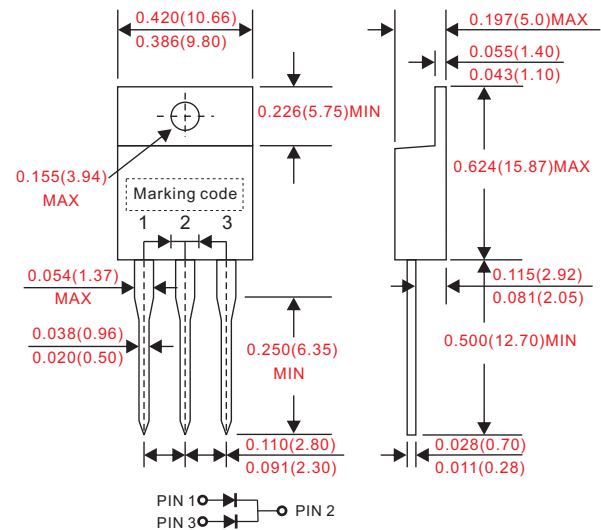
- Low forward voltage drop.
- Excellent high temperature stability.
- Fast switching capability.
- Suffix "G" indicates Halogen-free part, ex. CST10S40CTG.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228

### ■ Mechanical data

- Epoxy : UL94-V0 rated flame retardant.
- Case : JEDEC TO-220AB molded plastic body over passivated chip.
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guaranteed.
- Polarity: Color band denotes cathode end.
- Mounting Position : Any.
- Weight : Approximated 2.25 gram.

### ■ Outline

TO-220AB



### ■ Maximum ratings and electrical characteristics

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Parameter   | Conditions   | Symbol         | CST10S40CT | UNIT |
|---|--|----------------|------------|------|
| Marking code                                      |  |                | CST10S40CT |      |
| Peak repetitive reverse voltage                   |  | $V_{RRM}$      |            |      |
| Working peak reverse voltage                      |  | $V_{RWM}$      | 40         | V    |
| DC blocking voltage                               |  | $V_{RM}$       |            |      |
| Forward rectified current (total device)          | $T_c = 110^\circ\text{C}$  | $I_O$          | 10         | A    |
| Forward surge current (per diode)                 | 8.3ms single half sine-wave superimposed on rate load (JEDEC method) | $I_{FSM}$      | 150        | A    |
| Peak repetitive reverse surge current (per diode) | 2us - 1kHz   | $I_{RRM}$      | 3          | A    |
| Thermal resistance(1) (per diode)                 | Junction to case   | $R_{BJC}$      | 2          | °C/W |
| Operating and Storage temperature                 |  | $T_J, T_{STG}$ | -65 ~ +150 | °C   |

| Parameter                        | Conditions                               | Symbol | MIN. | TYP. | MAX. | UNIT |
|----------------------------------|--|--------|------|------|------|------|
| Forward voltage drop (per diode) | $I_F = 5A, T_J = 25^\circ\text{C}$       | $V_F$  |      |      | 440  | mV   |
|                                  | $I_F = 5A, T_J = 125^\circ\text{C}$      |        |      | 350  | 380  |      |
|                                  | $I_F = 10A, T_J = 25^\circ\text{C}$      |        |      |      | 520  |      |
| Reverse current (per diode)      | $V_R = V_{RRM}, T_J = 25^\circ\text{C}$  | $I_R$  |      |      | 0.5  | mA   |
|                                  | $V_R = V_{RRM}, T_J = 125^\circ\text{C}$ |        |      |      | 100  |      |

Note : 1. Thermal resistance from junction to case per leg, with heatsink size (1.35" x 0.95" x 0.18") Al-plate.

■ Rating and characteristic curves

Fig. 1 - Forward Power Dissipation (per diode)

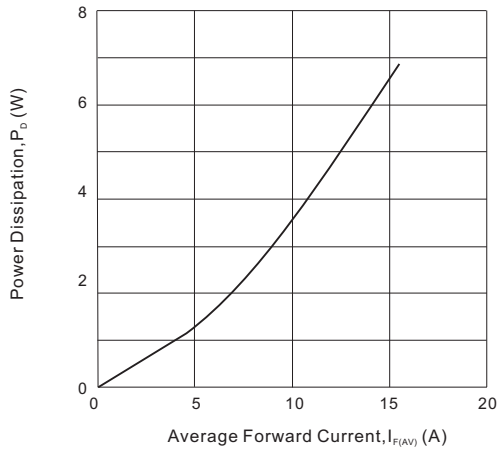


Fig. 2 - Instantaneous Forward Characteristics (per diode)

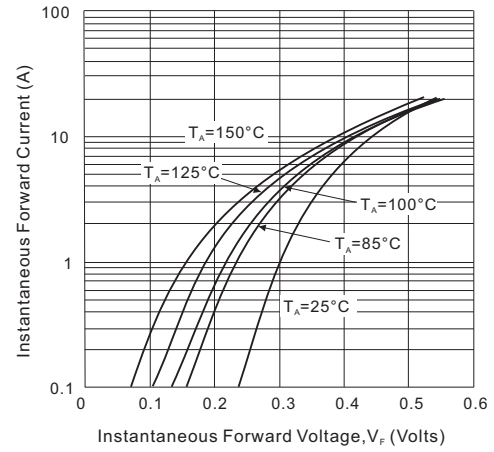


Fig. 3 - Reverse Characteristics (per diode)

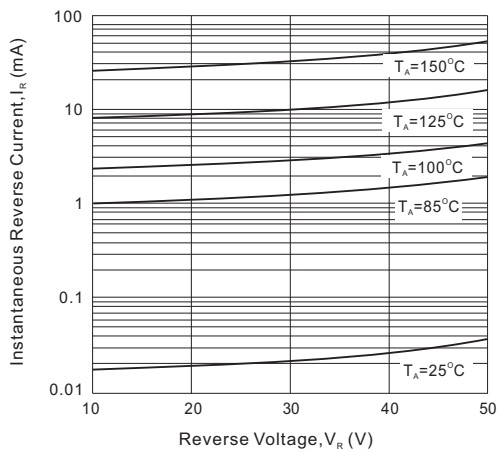
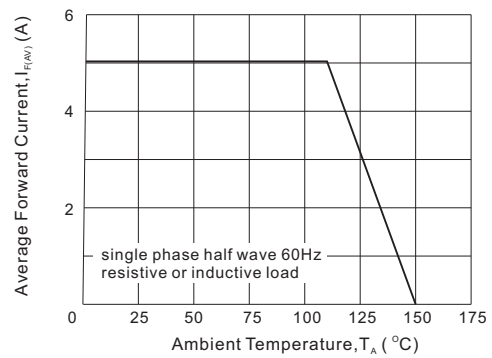


Fig. 4 - Forward Current Derating Curve (per diode)



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